

Smart Octal Low-Side Switch





Features Product Summary

- Short Circuit Protection
- Overtemperature Protection
- Overvoltage Protection
- 16 bit Serial Data Input and Diagnostic Output (2 bit/ch. acc. SPI protocol)

•	Direct Parallel	Control of Four	Channels for	r PWM Applications
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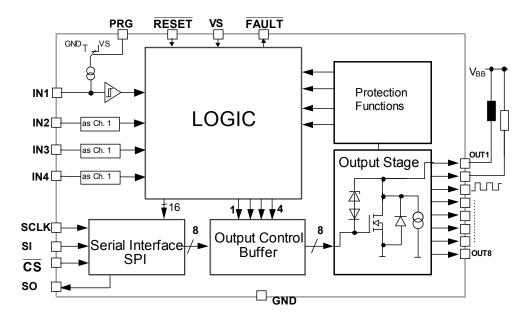
- Parallel Inputs High or Low Active Programmable
- · General Fault Flag
- Low Quiescent Current
- Compatible with 3,3 V Micro Controllers
- Electostatic Discharge (ESD) Protection
- Green Product (RoHS compliant)
- AEC Qualified

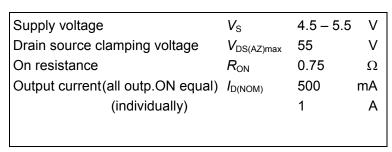
Application

- μC Compatible Power Switch for 12 V and 24V Applications
- Switch for Automotive and Industrial Systems
- Solenoids, Relays and Resistive Loads
- Robotic Controls

General description

Octal Low-Side Switch in Smart Power Technology (SPT) with a **S**erial **P**eripheral Interface (SPI) and eight open drain DMOS output stages. The TLE 6230 GP is protected by embedded protection functions and designed for automotive and industrial applications. The output stages are controlled via an SPI Interface. Additionally four channels can be controlled direct in parallel for PWM applications. Therefore the TLE 6230 GP is particularly suitable for engine management and powertrain systems.



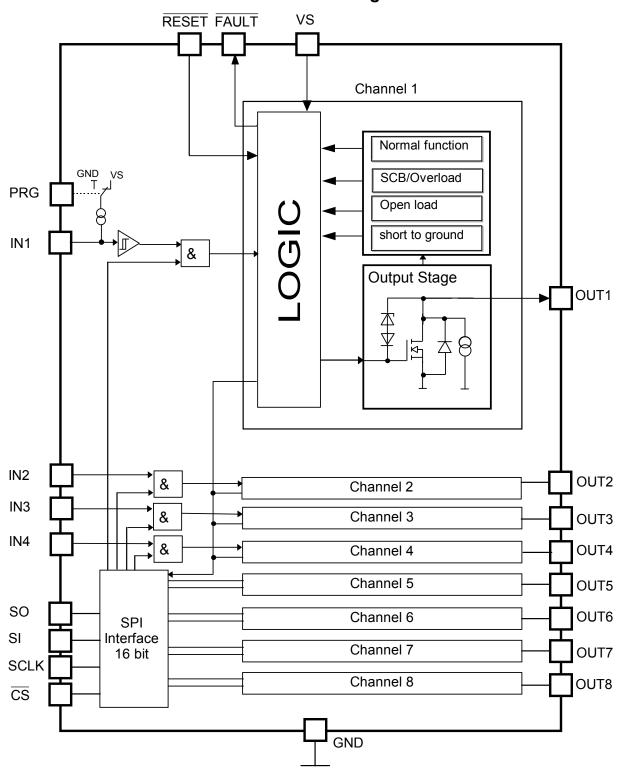






Block Diagram

Detailed Block Diagram





Pin Description

Pin	Symbol	Function	
1	GND	Ground	
2	NC	not connected	
3	NC	not connected	
4	OUT1	Power Output Channel 1	
5	OUT2	Power Output Channel 2	
6	IN1	Input Channel 1	
7	IN2	Input Channel 2	
8	VS	Supply Voltage	
9	RESET	Reset	
10	CS	Chip Select	
11	PRG	Program (inputs high or low-active)	
12	IN3	Input Channel 3	
13	IN4	Input Channel 4	
14	OUT3	Power Output Channel 3	
15	OUT4	Power Output Channel 4	
16	NC	not connected	
17	NC	not connected	
18	GND	Ground	
19	GND	Ground	
20	NC	not connected	
21	NC	not connected	
22	OUT5	Power Output Channel 5	
23	OUT6	Power Output Channel 6	
24	NC	not connected	
25	NC	not connected	
26	FAULT	General Fault Flag	
27	SO	Serial Data Output	
28	SCLK	Serial Clock	
29	SI	Serial Data Input	
30	NC	not connected	
31	NC	not connected	
32	OUT7	Power Output Channel 7	
33	OUT8	Power Output Channel 8	
34	NC	not connected	
35	NC	not connected	
36	GND	Ground	

Heat Slug internally connected to ground pins

Pin Configuration (Top view)

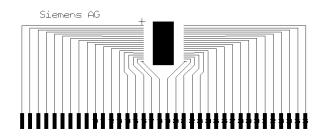
GND	1● 36		GND
NC	2	NC	
NC	3	34	NC
OUT1	4	33	OUT8
OUT2	5	32	OUT7
IN1	6	31	NC
IN2	7	30	NC
VS	8	29	SI
RESET	9	28	SCLK
\overline{CS}	10	27	SO
PRG	11	26	FAULT
IN3	12	25	NC
IN4	13	24	NC
OUT3	14	23	OUT6
OUT4	15	22	OUT5
NC	16	21	NC
NC	17	20	NC
GND	18	19	GND

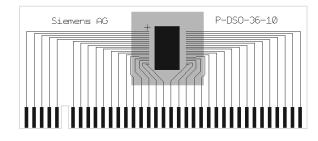
Power SO 36



Maximum Ratings for $T_j = -40$ °C to 150°C

Parameter	Symbol	Values	Unit
Supply Voltage	V _S	-0.3 + 7	V
Continuous Drain Source Voltage (OUT1OUT8)	V _{DS}	40	V
Input Voltage, All Inputs and Data Lines	V _{IN}	- 0.3 + 7	V
Load Dump Protection $V_{\text{Load Dump}} = U_P + U_S$; $U_P = 13.5 \text{ V}$	V _{Load Dump} ²)		V
With Automotive Relay Load R_L = 70 Ω		80	
R_{l}^{1} =2 Ω ; t_{d} =400ms; IN = low or high			
With R_L = 24 Ω ; R_I =2 Ω ; t_d =400ms; IN = high or low		52	
Operating Temperature Range	$T_{\rm j}$	- 40 + 150	°C
Storage Temperature Range	\mathcal{T}_{stg}	- 55 + 150	
Output Current per Channel (see el. characteristics)	I _{D(lim)}	I _{D(lim) min}	Α
Output Current per Channel @ T _A = 25°C	I _D	500	mA
(All 8 Channels ON; Mounted on PCB) ³⁾			
Output Clamping Energy (single pulse)	E _{AS}	50	mJ
$I_{\rm D} = 0.5 {\rm A}$			
Power Dissipation (mounted on PCB) @ T _A = 25°C	P _{tot}	3.3	W
Electrostatic Discharge Voltage (Human Body Model)			
according to MIL STD 883D, method 3015.7 and EOS/ESD assn. standard S5.1 – 1993			
Output 1-8 Pins	V _{ESD}	2000	V
All other Pins	V _{ESD}	2000	V
DIN Humidity Category, DIN 40 040		E	
IEC Climatic Category, DIN IEC 68-1		40/150/56	
Thermal Resistance			
junction - case	R_{thJC}	5	K/W
junction - ambient @ min. footprint	R_{thJA}	50	
junction - ambient @ 6 cm ² cooling area with heat pipes		38	





PCB with heat pipes, backside 6 cm² cooling area

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Minimum footprint

¹⁾ R_l =internal resistance of the load dump test pulse generator LD200
2) V_{LoadDump} is setup without DUT connected to the generator per ISO 7637-1 and DIN 40 839.
3) Output current rating so long as maximum junction temperature is not exceeded. At T_A = 125 °C the output current has to be calculated using R_{thJA} according mounting conditions.



Electrical Characteristics

Parameter and Conditions	Symbol	Values			Unit	
$V_S = 4.5 \text{ to } 5.5 \text{ V}$; $T_j = -40 \text{ °C to } + 150 \text{ °C}$; Reset = H		min	typ	max		
(unless otherwise specified)						
1. Power Supply, Reset						
Supply Voltage ⁴		V _S	4.5		5.5	V
Supply Current (outputs ON) ⁵		I _{S(ON)}		1	2	mΑ
Supply Current (outputs OFF) 5		I _{S(OFF)}		1	2	mA
Minimum Reset Duration		$t_{Reset,min}$	10			μs
2. Power Outputs						
ON Resistance $V_S = 5 \text{ V}$; $I_D = 500 \text{ mA}$	T _J = 25°C	R _{DS(ON)}		8.0	1	Ω
	$T_{\rm J} = 150^{\circ}{\rm C}$				1.7	
Output Clamping Voltage	Output OFF	V _{DS(AZ)}	40		55	V
Current Limit		$I_{D(lim)}$	1	1.5	2	Α
Output Leakage Current	V _{Reset} = L	I _{D(Ikg)}			5	μA
	V_{bb} =12 V	-(9)				
Turn-On Time $I_D = 0.5 \text{ A}, I_D$	resistive load	t _{ON}		8	12	μs
Turn-Off Time $I_D = 0.5 \text{ A}, I$	resistive load	t _{OFF}		6	10	μs
3. Digital Inputs						
Input Low Voltage		V _{INL}	- 0.3		1.0	V
Input High Voltage		V _{INH}	2.0			V
Input Voltage Hysteresis		V _{INHys}	50	100	200	mV
Input Pull Down/Up Current (IN1 IN4)		I _{IN(14)}	20	50	100	μA
PRG, Reset Pull Up Current		I _{IN(PRG,Res)}	20	50	100	μΑ
Input Pull Down Current (SI, SCLK)		I _{IN(SI,SCLK)}	10	20	50	μΑ
Input Pull Up Current (CS)	I _{IN(CS)}	10	20	50	μA	
4. Digital Outputs (SO, FAULT)						
SO High State Output Voltage	I _{SOH} = 2 mA	V _{SOH}	V _S - 0.4			V
SO Low State Output Voltage $I_{SOL} = 2.5 \text{ mA}$		V _{SOL}			0.4	V
Output Tri-state Leakage Current $\overline{\text{CS}}$ = F	H, $0 \le V_{SO} \le V_{S}$	I _{SOlkg}	-10	0	10	μA
FAULT Output Low Voltage IFA	_{AULT} = 1.6 mA	V_{FAULTL}			0.4	V

 $^{^4}$ For V_S < 4.5V the power stages are switched according the input signals and data bits or are definitely switched off. This undervoltage reset gets active at V_S = 3V (typ. value) and is guaranteed by design. 5 For Reset = H.

150

160

170

200

ns

ns

ns



Electrical Characteristics cont.

Disable Time @ $C_L = 50 \text{ pF}^6$

(CS high time between two accesses)

Transfer Delay Time⁷

Data Valid Time

Parameter and Conditions		Values	Values		
$V_{\rm S}$ = 4.5 to 5.5 V; $T_{\rm j}$ = -40 °C to + 150 °C; Reset = H (unless otherwise specified)		min	typ	max	
5. Diagnostic Functions					
Open Load Detection Voltage	$V_{\rm DS(OL)}$	V _S -2.5	V _S -2	V_S -1.3	V
Output Pull Down Current	$I_{PD(OL)}$	50	90	150	μA
Fault Delay Time	$t_{\sf d(fault)}$	50	100	200	μs
Short to Ground Detection Voltage	$V_{\rm DS(SHG)}$	V _S -3.3	V _S -2.9	V _S -2.5	V
Short to Ground Detection Current	I _{SHG}	-50	-100	-150	μA
Current Limitation; Overload Threshold Current	I _{D(lim) 18}	1	1.5	2	Α
Overtemperature Shutdown Threshold ⁶	$T_{th(sd)}$	170		200	°C
Hysteresis ⁶	T_{hys}		10		K
6. SPI-Timing					
Serial Clock Frequency (depending on SO load)	f _{SCK}	DC		5	MHz
Serial Clock Period (1/fclk)	$t_{\scriptscriptstyle p(SCK)}$	200			ns
Serial Clock High Time	$t_{\scriptscriptstyle \sf SCKH}$	50			ns
Serial Clock Low Time	$t_{\scriptscriptstyle \sf SCKL}$	50			ns
Enable Lead Time (falling edge of $\overline{\text{CS}}$ to rising edge of CLK)	t_{lead}	250			ns
Enable Lag Time (falling edge of CLK to rising edge of $\overline{\text{CS}}$)	t_{lag}	250			ns
Data Setup Time (required time SI to falling of CLK)	<i>t</i> _{su}	20			ns
Data Hold Time (falling edge of CLK to SI)	<i>t</i> _H	20			ns
<u> </u>					

 t_{DIS}

 $t_{
m dt}$

 t_{valid}

200

110

120

150

 $C_L = 50 \text{ pF}^6$

 $C_L = 100 pF^6$

 $C_L = 220 pF^6$

⁶ This parameter will not be tested but guaranteed by design ⁷ This time is necessary between two write accesses. To get the correct diagnostic information, the transfer delay time has to be extended to the maximum fault delay time $t_{d(fault)max} = 200 \mu s$.



Functional Description

The TLE 6230 GP is an octal-low-side power switch which provides a serial peripheral interface (SPI) to control the 8 power DMOS switches, as well as diagnostic feedback. The power transistors are protected against short to $V_{\rm BB}$, overload, overtemperature and against overvoltage by an active zener clamp.

The diagnostic logic recognizes a fault condition which can be read out via the serial diagnostic output (SO).

Circuit Description

Output Stage Control

Each output is independently controlled by an output latch and a common reset line, which disables all eight outputs. Serial data input (SI) is read on the falling edge of the serial clock. A logic high input data bit turns the respective output channel ON, a logic low data bit turns it OFF. $\overline{\text{CS}}$ must be low whilst shifting all the serial data into the device. A low-to-high transition of $\overline{\text{CS}}$ transfers the serial data input bits to the output buffer.

Special conditions for Channel 1 to 4:

In addition to the serial control of the outputs it is possible to control channel 1 to channel 4 directly in parallel for PWM applications. These inputs are high or low active (programmable via PRG pin) and ANDed with the SPI control bit.

The table shows the AND-operation of the parallel input pin (here active high) and the corresponding SPI bit. For an application where the parallel input is always "ON", it is possible to switch the channel OFF via the SPI bit, e.g. for diagnosis in OFF-state.

IN 1 - 4	SPI-Bit 0 - 3	OUT 1 - 4
0	0	OFF
0	1	OFF
1	0	OFF
1	1	ON

⇒ SPI Priority for OFF-state

Operation with parallel inputs: Set SPI bits to logic high.

Operation via SPI: Connect parallel inputs to logic high (if programmed to active high).

PRG - Program pin. PRG = High (V_S): Parallel inputs Channel 1 to 4 are high active PRG = Low (GND): Parallel inputs Channel 1 to 4 are low active.

If the parallel input pins are not connected (independent of high or low activity) it is guaranteed that the channels 1 to 4 are switched OFF.

PRG pin itself is internally pulled up when it is not connected.



Power Transistor Protection Functions⁸⁾

Each of the eight output stages has its own zener clamp, which causes a voltage limitation at the power transistor when solenoid loads are switched off. The outputs are provided with a current limitation set to a minimum of 1 A. The continuous current for each channel is 500 mA (all channels ON).

Each output is protected by embedded protection functions. In the event of an overload or short to supply, the current is internally limited and the corresponding bit combination is set (early warning). If this operation leads to an overtemperature condition, a second protection level (about 170 °C) will change the output into a low duty cycle PWM (selective thermal shutdown with restart) to prevent critical chip temperatures.

SPI Signal Description

CS - Chip Select. The system microcontroller selects the TLE 6230 GP by means of the CS pin. Whenever the pin is in a logic low state, data can be transferred from the μC and vice versa.

- **CS High to Low transition:** diagnostic status information is transferred from the power outputs into the shift register.
 - serial input data can be clocked in from then on
 - SO changes from high impedance state to logic high or low state corresponding to the SO bits

- CS Low to High transition: transfer of SI bits from shift register into output buffers
 - reset of diagnosis register

To avoid any false clocking the serial clock input pin SCLK should be logic low state during high to low transition of $\overline{\text{CS}}$. When CS is in a logic high state, any signals at the SCLK and SI pins are ignored and SO is forced into a high impedance state.

SCLK - Serial Clock. The system clock pin clocks the internal shift register of the TLE 6230 GP. The serial input (SI) accepts data into the input shift register on the falling edge of SCLK while the serial output (SO) shifts diagnostic information out of the shift register on the rising edge of serial clock. It is essential that the SCLK pin is in a logic low state whenever chip select CS makes any transition. The number of clock pulses will be counted during a chip select cycle. The received data will only be accepted, if exactly 16 clock pulses were counted during CS is active.

SI - Serial Input. Serial data bits are shifted in at this pin, the most significant bit first. SI information is read in on the falling edge of SCLK. Input data is latched in the shift register and then transferred to the control buffer of the output stages.

The input data consists of two bytes - a "control byte" followed by a "data byte". The control byte contains the information as to whether the data byte will be accepted or ignored (see diagnostics section). The data byte contains the input information for the eight channels. A logic

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⁸⁾ The integrated protection functions prevent an IC destruction under fault conditions and may not be used in normal operation or permanently



high level at this pin (within the data byte) will switch on the power switch, provided that the corresponding parallel input is also switched on (AND-operation for channel 1 to 4).

SO - Serial Output. Diagnostic data bits are shifted out serially at this pin, the most significant bit first. SO is in a high impedance state until the $\overline{\text{CS}}$ pin goes to a logic low state. New diagnostic data will appear at the SO pin following the rising edge of SCLK.

RESET - Reset pin. If the reset pin is in a logic low state, it clears the SPI shift register and switches all outputs OFF. An internal pull-up structure is provided on chip.

Diagnostics

 $\overline{\text{FAULT}}$ - Fault pin. There is a general fault pin (open drain) which shows a high to low transition as soon as an error occurs for any one of the eight channels. This fault indication can be used to generate a μC interrupt. Therefore a 'diagnosis' interrupt routine need only be called after this fault indication. This saves processor time compared to a cyclic reading of the SO information.

As soon as a fault occurs, the fault information is latched into the diagnosis register. A new error will over-write the old error report. Serial data out pin (SO) is in a high impedance state when \overline{CS} is high. If \overline{CS} receives a LOW signal, all diagnosis bits can be shifted out serially. The rising edge of \overline{CS} will reset all error registers.

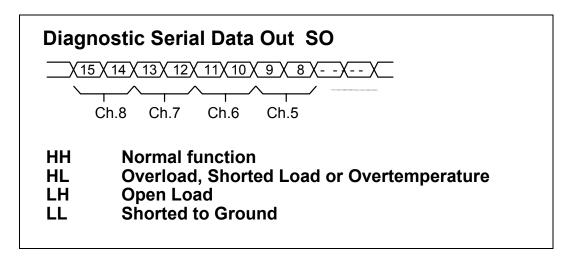


Figure 1: Two bits per channel diagnostic feedback

There are two diagnostic bits per channel configured as shown in Figure 1.

Normal function: The bit combination **HH** indicates that there is no fault condition, i.e. normal function.

Overload, Short Circuit to Battery (SCB) or Overtemperature: HL is set when the current limitation gets active, i.e. there is a overload, short to supply or overtemperature condition.

Open load: An open load condition is detected when the drain voltage decreases below 3 V (typ.). **LH** bit combination is set.

Short Circuit to GND: If a drain to ground short circuit exists and the drain to ground current exceeds 100 µA, short to ground is detected and the **LL** bit combination is set.



A definite distinction between open load and short to ground is guaranteed by design.

The standard way of obtaining diagnostic information is as follows:

Clock in serial information into SI pin and wait approximately 150 µs to allow the outputs tosettle. Clock in the identical serial information once again - during this process the data coming out at SO contains the bit combinations representing the diagnosis conditions as described in figure 1.

By means of the control byte it is possible either to:

- a) control the eight outputs according to the data byte, as well as being able to read the diagnostic information
- or b) purely get diagnostic information without changing the state of the outputs.
- a) Serial Control of Outputs

HHHHHHH LHLHHLLL : Serial input information

Control Byte Data Byte

Control byte is set to FFhex: Data byte will be accepted. The outputs will be switched ON or OFF according to the information of the data byte and the parallel inputs (Channel 1 to 4 because of AND operation).

All other control words except the one for 'Diagnosis Only = 00hex' will also be accepted as a valid control word and the data will be accepted.

Example: HLLHLHLH DDDDDDDD: Outputs will switch according to the data bits.

b) Diagnosis Only

LLLLLLL XXXXXXXX: Serial input information

Control Byte Data Byte

Control byte is set to 00hex: Data byte will be ignored. Diagnostic information can be read out at any time with no change of the switching conditions. Only 00hex means 'Diagnosis Only'.



Timing Diagrams

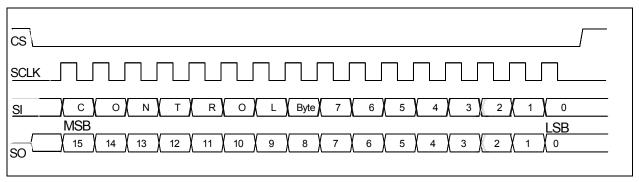


Figure 2: Serial Interface

Figure 3: Input Timing Diagram

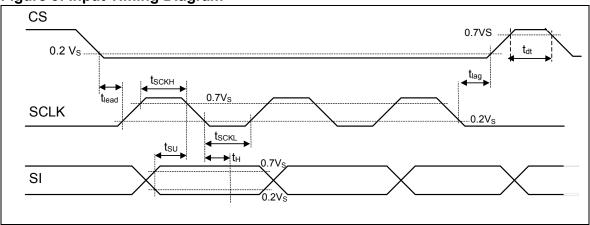
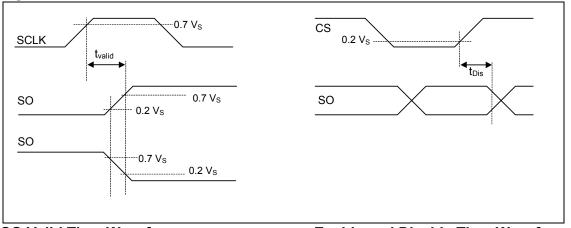


Figure 4:



SO Valid Time Waveforms

Enable and Disable Time Waveforms



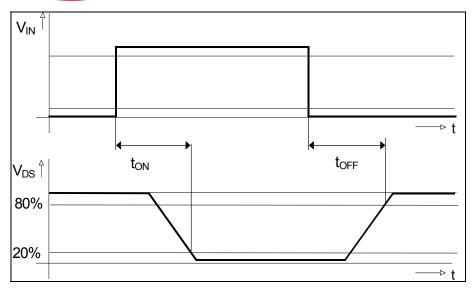
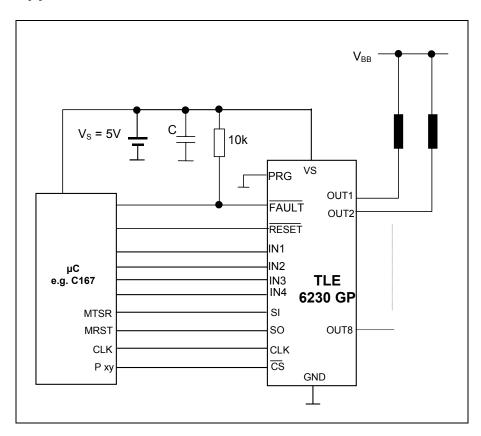


Figure 5: Power Outputs

Timing is valid for resistive lead with

Timing is valid for resistive load with parallel and serial control. Rising edge of chip select initiates the switching

Application Circuits





Typical electrical Characteristics

Drain-Source on-resistance

 $R_{DS(ON)} = f(T_i)$; $V_s = 5V$

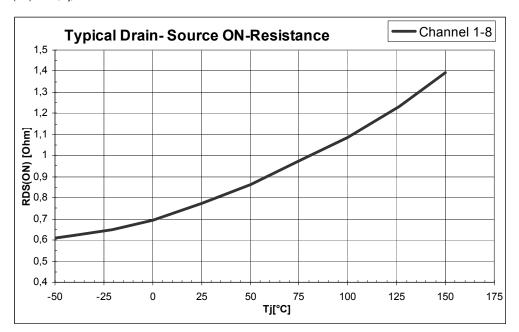


Figure 6: Typical ON Resistance versus Junction-Temperature Channel 1-8

Output Clamping Voltage

 $V_{DS(AZ)} = f(T_i)$; $V_s = 5V$

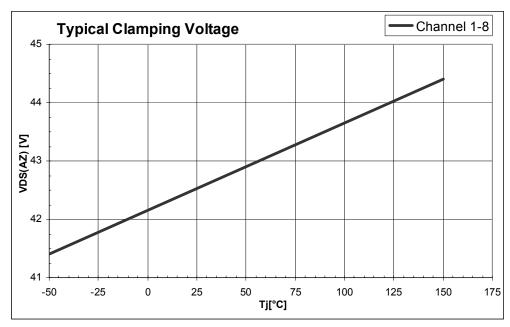


Figure 7: Typical Clamp Voltage versus Junction-Temperature Channel 1-8



Maximum single clamp Energy

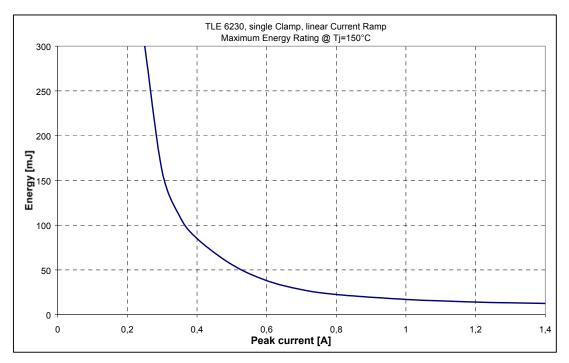
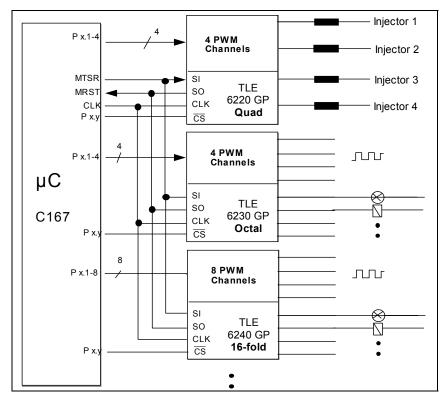


Figure 8: Maximum Clamp Energy (single event) versus Peak Current Channel 1-8

Parallel SPI Configuration



Engine Management Application

TLE 6230 GP in combination with TLE 6240 GP (16-fold switch) for relays and general purpose loads and TLE 6220 GP (quad switch) to drive the injector valves. This arrangement covers the numerous loads to be driven in a modern Engine Management/Powertrain system. From 28 channels in sum 16 can be controlled direct in parallel for PWM applications.

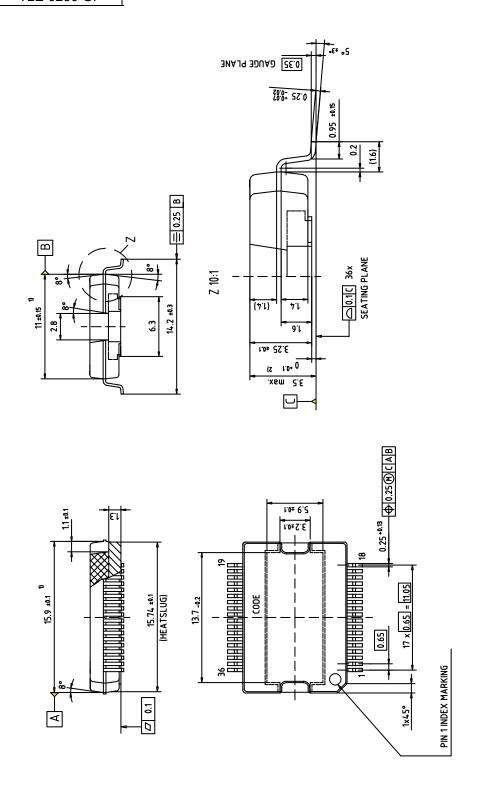


Package and Ordering Code

(all dimensions in mm)

PG-DSO 36

TLE 6230 GP





Edition 2008-04-17
Published by
Infineon Technologies AG
81726 Munich, Germany
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